

RECC

09-16-2004



102837703

To the Director of the U.S. Patent and Trademark Office

the new address(es) below.

1. Name of conveying party(ies)/Executive
Min-Lung HUANG

2. Name and address of receiving party(ies)

Advanced Semiconductor Engineering
Inc.

Name: _____

Internal Address: _____

Street Address: _____

Execution Dates: August 19, 2004

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

No. 26, Jing 3rd Rd.,
Nanzih District

City: Kaohsiung City

State: _____

Country: Taiwan, Republic of China Zip: 811

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of Conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other _____

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

NEW

B. Patent No.(s)

10936569

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Joe McKinney Muncy
BIRCH, STEWART, KOLASCH & BIRCH,
LLP

Internal Address: Atty. Dkt.: 0941-1033PUS1

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State: VA Zip: 22040-0747

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Email Address: mailroon@bskb.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged to credit card
☐ Authorized to be charged to deposit account
☒ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information:

- a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number _____
Authorized User Name _____

9. Signature.

Signature

September 9, 2004

Date

Joe McKinney Muncy - 32,334

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

2

KM/nl

17497 U.S. PTO
10/936569
090904

ASSIGNMENT

WHEREAS, Min-Lung HUANG
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:

Title: SOLDER BUMP STRUCTURE AND METHOD FOR FORMING THE SAME

Filed: September 9, 2004

Serial No. NEW

Executed on: August 19, 2004

WHEREAS, Advanced Semiconductor Engineering Inc. of No. 26, Jing 3rd Rd., Nanzih District, Kaohsiung City 811, Taiwan, R.O.C.
hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the
said invention and application and in any U.S. Letters Patent which may be granted on the
same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for
good and valuable consideration, receipt of which is hereby acknowledged by Assignor,
Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign
and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their
rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on
the same in the United States, the said interest to be held and enjoyed by said Assignee as
fully and exclusively as it would have been held and enjoyed by said Assignor had this
Assignment and transfer not been made, to the full end and term of any Letters Patent which
may be granted thereon, or of any division, renewal, continuation in whole or in part,
substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said
Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments
of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may
request, to obtain or maintain Letters Patent for said invention and improvement, and to vest
title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the
date(s) indicated.

Min - Lung Huang
Min-Lung HUANG

8/19/04
Date: